## **Electronic Acknowledgement Receipt** FES ID: 1235397 Application Number: 10801954 Confirmation Number: 2359 Title of Invention: Method and system for analyzing defects of an integrated circuit wafer First Named Inventor: Shu-Sing Liao Customer Number: 22470 Filer: Warren Scott Wolfeld Filer Authorized By: Attorney Docket Number: MXIC 1555-1 Receipt Date: 04-OCT-2006 Filing Date: 16-MAR-2004 Time Stamp: 16:19:47 Application Type: Utility International Application Number: Payment information:

## File Listing:

Submitted with Payment

ĺ	Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
	1		RESPONSE_A.pdf	219565	yes	10

no

	Multipart Description					
	Doc Desc	Start	End			
	Response to Election / Restriction Filed	1	1			
	Claims	2	9			
	Applicant Arguments/Remarks Made in an Amendment	10	10			
Warnings:						

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## New Applications Under 35 U.S.C. 111

Information:

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.